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2021 The 6th International Conference on Integrated Circuits and Microsystem

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CALL FOR PAPERS

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October 22-24, 2021

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TOPICS

* Digital, Analog, Mixed Signal IC and SOC design technology

* Silicon integrated circuits and manufacturing

* Low-power, RF devices & circuits

* IC Computer-Aided –Design technology, DFM

* Silicon/germanium devices and device physics

* Interconnect, Low K, High K and other process technologies

* Unconventional and nano-electronics

* Organic semiconductor devices and technologies

* Compound semiconductor devices and circuits

* Displays, sensors and MEMS

* Solar cell & other devices for new energy sources

* Modeling and simulation

* Displays, sensors and MEMS

* Advance memories technology (Flash, FeRAM, PCM, ReRAM, MRAM etc.)

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Ei Compendex, and Scopus indexed conference

proceedings

Papers of ICICM 2016-2020 can be checked in IEEE Xplore!

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Submission

Link:

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Submission deadline: **September 10, 2021**

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